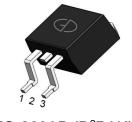




N-Channel 60V (D-S) Power MOSFET

Features

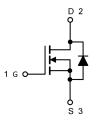
- 100% Avalanche Tested
- Extremely Low Losses with Low FOM Rdson*Qg
- Halogen Free, Pb-Free
- RoHS Compliant



TO-263AB (D²PAK)

Applications

- DC/DC
- Motors, lamps
- Power switching



Absolute Maximum Ratings (T _J =25°C unless otherwise noted)					
Parameter		Symbol	Value	Unit	
Drain Source Voltage		V _{DS}	60	V	
Gate Source Voltage		V_{GS}	±20	V	
Drain Current, Continuous V _{GS} =10V(<i>Note 1</i>)	T _C =25°C	I _D	80	Α	
Drain Current, Pulsed (Note 2)		I _{DM}	320	Α	
Single Avalanche Energy @ L=0.5mH		Eas	274	mJ	
Power Dissipation(Note 3) T _C =25°C		P _D	192	W	
Operating Junction/ Storage Temperature Range		TJ/ Tstg	-55 to +150	°C	

Note 1: Calculated continuous current based on maximum allowable junction temperature.

Note 2: Repetitive rating; pulse width limited by max. junction temperature.

Thermal Characteristics			
Parameter	Symbol	Max	Unit
Thermal Resistance Junction to Case(Note 3)	R _{thJC}	0.65	°C/W

Note 3: The power dissipation PD is based on max. junction temperature, using junction-to-case thermal resistance.



Electrical Characteristics (T _J =25°C unless otherwise noted)						
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Drain Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	60			٧
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V, V _{GS} =0V			1	uA
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _{DS} =250uA	2		4	V
Gate Leakage Current	I _{GSS}	V _{GS} =±10V, V _{DS} =0V			±100	nA
Drain-Source On-state Resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A		6.5	8	mΩ
Total Gate Charge	Qg			70		
Gate Source Charge	Q _{gs}	I _D = 30A, V _{DS} =30V,		16		nC
Gate Drain Charge	Q_{gd}	V _{GS} = 15V		23		
Turn-on Delay Time	t _{d(on)}			17		
Turn-on Rise Time	t _r	V _{GS} =10V, V _{DS} =30V,		31.9		
Turn-off Delay Time	t _{d(off)}	$R_{GEN}=3\Omega$, $I_D=30A$		45		ns
Turn-off Fall Time	t _f			14.4		
Input Capacitance	C _{iss}			2940		
Output Capacitance	Coss	V _{GS=} 0V, V _{DS} =50V, f=1MHz		178		pF
Reverse Transfer Capacitance	C _{rss}			154		

Reverse Diode Characteristics (T _J =25°C unless otherwise noted)						
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Continuous Source Current (Body Diode)	Is	T _C =25°C			80	А
Pulsed Source Current (Body Diode)	I _{SM}	1 C-25 C			320	
Diode Forward Voltage	V _{SD}	I _S =30A, V _{GS} =0V		0.87	1.2	V
Reverse Recovery Time	Trr	L = 20A di/dt = 100 A/up		30		ns
Reverse Recovery Charge	Qrr	I _F =30A, di/dt = 100 A/μs		30		nC

Typical Characteristics Curves (T_J = 25°C unless otherwise noted)



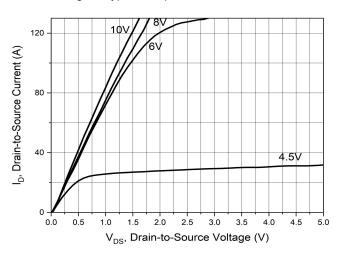


Fig.3 - RDS(on) vs. Junction Temperature

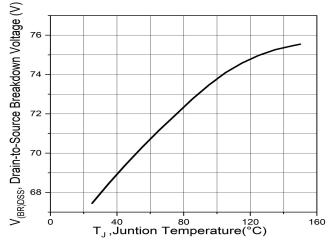
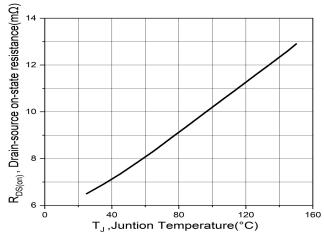
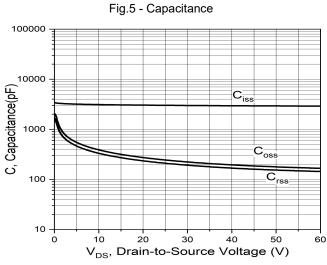


Fig.2 - Drain-to-Source Breakdown Voltage vs. Junction

Temperature

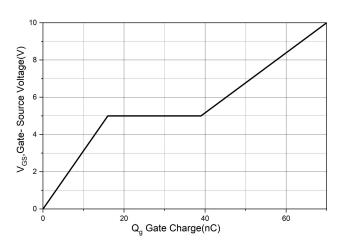
Fig.4 - Vth vs. Junction Temperature





2.8 V_{GS}-Gate-to-Source Voltage(V) 1.6 T_J,Juntion Temperature(°C) 160

Fig.6 - Gate Charge





Typical Characteristics Curves (T_J = 25°C unless otherwise noted)

Fig.7 - Transfer Characteristics

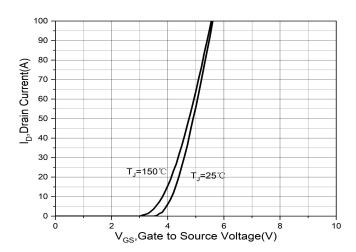
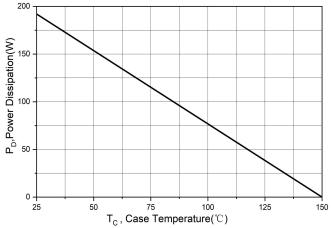


Fig.8 - Power Dissipation

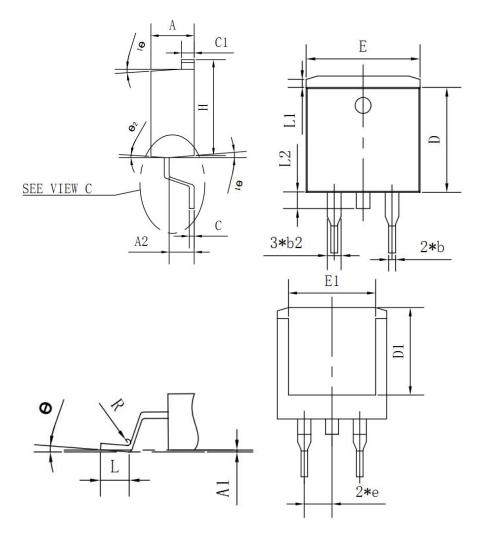




Package Outline Dimensions (Unit: millimeters)

TO-263

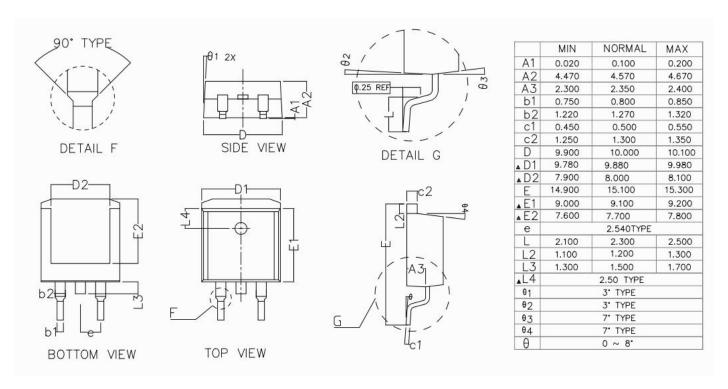
Option 1



SYMBOL	MIN	NOM	MAX
A	4. 35	4. 47	4. 60
A1	0. 09	0.10	0.11
A2	2. 30	2. 40	2. 50
Ь	0.70	0.80	1.00
Ь2	1. 25	1.36	1. 38
С	0. 45	0.50	0. 55
C1	1. 29	1.30	1. 31
D	9. 10	9. 20	9. 30
D1	7. 90	8.00	8. 10
Е	9. 85	10.00	10. 20
E1	7. 90	8.00	8. 10
Н	15. 30	15. 50	15. 70
e	-	2. 54	8#6
L	2. 34	2. 54	2. 74
L1	1.00	1. 10	1. 20
L2	1. 30	1.40	1.50
R	0. 24	0.25	0. 26
ө	0°	4°	8°
0 1	4"	7°	10°
Θ2	0°	3°	6°



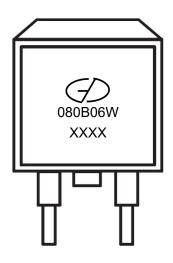
Option2







Marking Outline



Part Name: GMN080B06W

1. Logo Mark:

2. P/N Mark: 080B06W

3. Date Code: XXXX



GOOD-ARK Electronics

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